

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM30GP60

eupec



### Elektrische Eigenschaften / Electrical properties

#### Höchstzulässige Werte / Maximum rated values

##### Diode Gleichrichter/ Diode Rectifier

Periodische Rückw. Spitzensperrspannung repetitive peak reverse voltage		$V_{RRM}$	1600	V
Durchlaßstrom Grenzeffektivwert RMS forward current per chip		$I_{FRMSM}$	40	A
Dauergleichstrom DC forward current	$T_C = 80^\circ\text{C}$	$I_d$	30	A
Stoßstrom Grenzwert surge forward current	$t_p = 10\text{ ms}, T_{vj} = 25^\circ\text{C}$	$I_{FSM}$	300	A
	$t_p = 10\text{ ms}, T_{vj} = 150^\circ\text{C}$		230	A
Grenzlastintegral $I^2t$ - value	$t_p = 10\text{ ms}, T_{vj} = 25^\circ\text{C}$	$I^2t$	450	$\text{A}^2\text{s}$
	$t_p = 10\text{ ms}, T_{vj} = 150^\circ\text{C}$		260	$\text{A}^2\text{s}$

##### Transistor Wechselrichter/ Transistor Inverter

Kollektor-Emitter-Sperrspannung collector-emitter voltage		$V_{CES}$	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ\text{C}$	$I_{C,nom.}$	30	A
	$T_C = 25^\circ\text{C}$	$I_C$	50	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$	$I_{CRM}$	60	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ\text{C}$	$P_{tot}$	180	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

##### Diode Wechselrichter/ Diode Inverter

Dauergleichstrom DC forward current	$T_C = 80^\circ\text{C}$	$I_F$	30	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	$I_{FRM}$	60	A
Grenzlastintegral $I^2t$ - value	$V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^\circ\text{C}$	$I^2t$	240	$\text{A}^2\text{s}$

##### Transistor Brems-Chopper/ Transistor Brake-Chopper

Kollektor-Emitter-Sperrspannung collector-emitter voltage		$V_{CES}$	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ\text{C}$	$I_{C,nom.}$	15	A
	$T_C = 25^\circ\text{C}$	$I_C$	25	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$	$I_{CRM}$	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ\text{C}$	$P_{tot}$	100	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

##### Diode Brems-Chopper/ Diode Brake-Chopper

Dauergleichstrom DC forward current	$T_C = 80^\circ\text{C}$	$I_F$	10	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	$I_{FRM}$	20	A

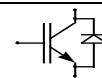
prepared by: Andreas Schulz	date of publication: 17.09.1999
approved by: M.Hierholzer	revision: 4

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM30GP60

eupec



### Modul Isolation/ Module Isolation

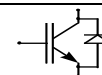
Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min. NTC connected to Baseplate	V <sub>ISOL</sub>	2,5	kV
--	--	-------------------	-----	----

### Elektrische Eigenschaften / Electrical properties

#### Charakteristische Werte / Characteristic values

Diode Gleichrichter/ Diode Rectifier		min.	typ.	max.	
Durchlaßspannung forward voltage	T <sub>vj</sub> = 150°C, I <sub>F</sub> = 30 A	V <sub>F</sub>	-	1,1	1,15 V
Schleusenspannung threshold voltage	T <sub>vj</sub> = 150°C	V <sub>(TO)</sub>	-	-	0,8 V
Ersatzwiderstand slope resistance	T <sub>vj</sub> = 150°C	r <sub>T</sub>	-	-	10,5 mΩ
Sperrstrom reverse current	T <sub>vj</sub> = 150°C, V <sub>R</sub> = 1600 V	I <sub>R</sub>	-	2	- mA
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	T <sub>C</sub> = 25°C	R <sub>AA'+CC'</sub>	-	8	- mΩ

Transistor Wechselrichter/ Transistor Inverter		min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	V <sub>GE</sub> = 15V, T <sub>vj</sub> = 25°C, I <sub>C</sub> = 30 A	V <sub>CE sat</sub>	-	1,95	2,45 V
	V <sub>GE</sub> = 15V, T <sub>vj</sub> = 125°C, I <sub>C</sub> = 30 A		-	2,2	- V
Gate-Schwellenspannung gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , T <sub>vj</sub> = 25°C, I <sub>C</sub> = 0,7 mA	V <sub>GE(TO)</sub>	4,5	5,5	6,5 V
Eingangskapazität input capacitance	f = 1MHz, T <sub>vj</sub> = 25°C V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V	C <sub>ies</sub>	-	1,6	- nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 25°C, V <sub>CE</sub> = 600 V	I <sub>CES</sub>	-	1,0	500 μA
	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 125°C, V <sub>CE</sub> = 600 V		-	1,2	- mA
Gate-Emitter Reststrom gate-emitter leakage current	V <sub>CE</sub> = 0V, V <sub>GE</sub> = 20V, T <sub>vj</sub> = 25°C	I <sub>GES</sub>	-	-	300 nA
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 300 V	t <sub>d,on</sub>	-	50	- ns
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 33 Ohm				
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 33 Ohm				
Anstiegszeit (induktive Last) rise time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 300 V	t <sub>r</sub>	-	50	- ns
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 33 Ohm				
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 33 Ohm				
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 300 V	t <sub>d,off</sub>	-	250	- ns
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 33 Ohm				
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 33 Ohm				
Fallzeit (induktive Last) fall time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 300 V	t <sub>f</sub>	-	30	- ns
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 33 Ohm				
	V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 33 Ohm				
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 33 Ohm L <sub>S</sub> = 75 nH	E <sub>on</sub>	-	1,4	- mWs
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 300 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 33 Ohm L <sub>S</sub> = 75 nH	E <sub>off</sub>	-	1	- mWs
Kurzschlußverhalten SC Data	t <sub>p</sub> ≤ 10μs, V <sub>GE</sub> ≤ 15V, R <sub>G</sub> = 33 Ohm T <sub>vj</sub> ≤ 125°C, V <sub>CC</sub> = 360 V di/dt = 1800 A/μs	I <sub>SC</sub>	-	120	- A



**Elektrische Eigenschaften / Electrical properties**

**Charakteristische Werte / Characteristic values**

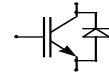
		min.	typ.	max.			
Modulinduktivität stray inductance module		$L_{\sigma CE}$	-	-	100 nH		
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^\circ C$	$R_{CC'+EE'}$	-	11	- mΩ		
<b>Diode Wechselrichter/ Diode Inverter</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Durchlaßspannung forward voltage	$V_{GE} = 0V, T_{vj} = 25^\circ C, I_F = 30 A$ $V_{GE} = 0V, T_{vj} = 125^\circ C, I_F = 30 A$	$V_F$	-	1,25	1,7	V	
Rückstromspitze peak reverse recovery current	$I_F = I_{Nenn}, - di_F/dt = 900A/\mu s$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	$I_{RM}$	-	26	-	A	
Sperrverzögerungsladung recovered charge	$I_F = I_{Nenn}, - di_F/dt = 900A/\mu s$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	$Q_r$	-	2,5	-	μAs	
Abschaltenergie pro Puls reverse recovery energy	$I_F = I_{Nenn}, - di_F/dt = 900A/\mu s$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	$E_{RO}$	-	0,5	-	mWs	
<b>Transistor Brems-Chopper/ Transistor Brake-Chopper</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$V_{GE} = 15V, T_{vj} = 25^\circ C, I_C = 15,0 A$ $V_{GE} = 15V, T_{vj} = 125^\circ C, I_C = 15,0 A$	$V_{CE sat}$	-	1,95	2,45	V	
Gate-Schwellenspannung gate threshold voltage	$V_{CE} = V_{GE}, T_{vj} = 25^\circ C, I_C = 0,4 mA$	$V_{GE(TO)}$	4,5	5,5	6,5	V	
Eingangskapazität input capacitance	$f = 1MHz, T_{vj} = 25^\circ C$ $V_{CE} = 25 V, V_{GE} = 0 V$	$C_{ies}$	-	0,8	-	nF	
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{GE} = 0V, T_{vj} = 25^\circ C, V_{CE} = 600 V$ $V_{GE} = 0V, T_{vj} = 125^\circ C, V_{CE} = 600 V$	$I_{CES}$	-	0,5	500	μA	
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0V, V_{GE} = 20V, T_{vj} = 25^\circ C$	$I_{GES}$	-	-	300	nA	
<b>Diode Brems-Chopper/ Diode Brake-Chopper</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Durchlaßspannung forward voltage	$T_{vj} = 25^\circ C, I_F = 15,0 A$ $T_{vj} = 125^\circ C, I_F = 15,0 A$	$V_F$	-	1,4	1,95	V	
<b>NTC-Widerstand/ NTC-Thermistor</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Nennwiderstand rated resistance	$T_C = 25^\circ C$	$R_{25}$	-	5	-	kΩ	
Abweichung von $R_{100}$ deviation of $R_{100}$	$T_C = 100^\circ C, R_{100} = 493 \Omega$	$\Delta R/R$	-5		5	%	
Verlustleistung power dissipation	$T_C = 25^\circ C$	$P_{25}$			20	mW	
B-Wert B-value	$R_2 = R_1 \exp [B(1/T_2 - 1/T_1)]$	$B_{25/50}$		3375		K	

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM30GP60

eupec

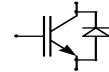


### Thermische Eigenschaften / Thermal properties

		min.	typ.	max.		
Innerer Wärmewiderstand thermal resistance, junction to case	Gleichr. Diode/ Rectif. Diode	$R_{thJC}$	-	-	1	K/W
	Trans. Wechr./ Trans. Inverter		-	-	0,7	K/W
	Diode Wechr./ Diode Inverter		-	-	1,2	K/W
	Trans. Bremse/ Trans. Brake		-	-	1,3	K/W
	Diode Bremse/ Diode Brake		-	-	2,3	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleichr. Diode/ Rectif. Diode	$R_{thCK}$	-	0,08	-	K/W
	Trans. Wechr./ Trans. Inverter		-	0,04	-	K/W
	Diode Wechr./ Diode Inverter		-	0,08	-	K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj}$	-	-	150	°C
Betriebstemperatur operation temperature		$T_{op}$	-40	-	125	°C
Lagertemperatur storage temperature		$T_{stg}$	-40	-	125	°C

### Mechanische Eigenschaften / Mechanical properties

Innere Isolation internal insulation				$Al_2O_3$	
CTI comperative tracking index				225	
Anzugsdrehmoment f. mech. Befestigung mounting torque		M		3 ±10%	Nm
Gewicht weight		G		180	g

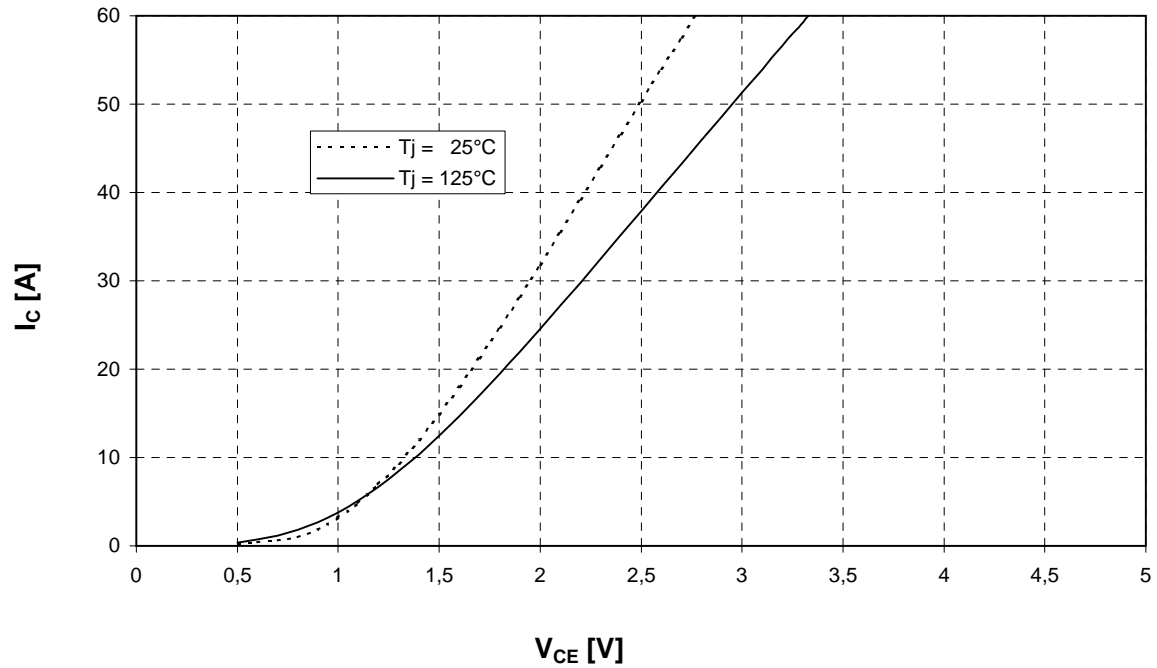


**Ausgangskennlinienfeld Wechselr. (typisch)**

$d = f(V_{CE})$

**Output characteristic Inverter (typical)**

$V_{GE} = 15\text{ V}$

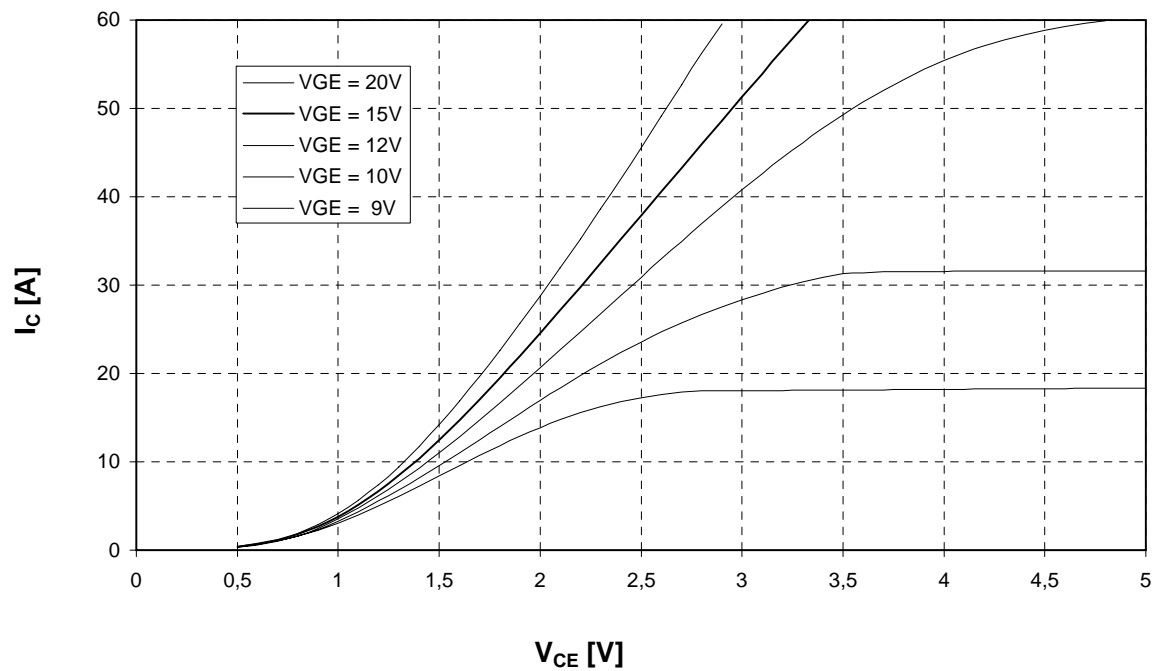


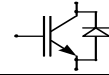
**Ausgangskennlinienfeld Wechselr. (typisch)**

$d = f(V_{CE})$

**Output characteristic Inverter (typical)**

$T_{vj} = 125^\circ\text{C}$



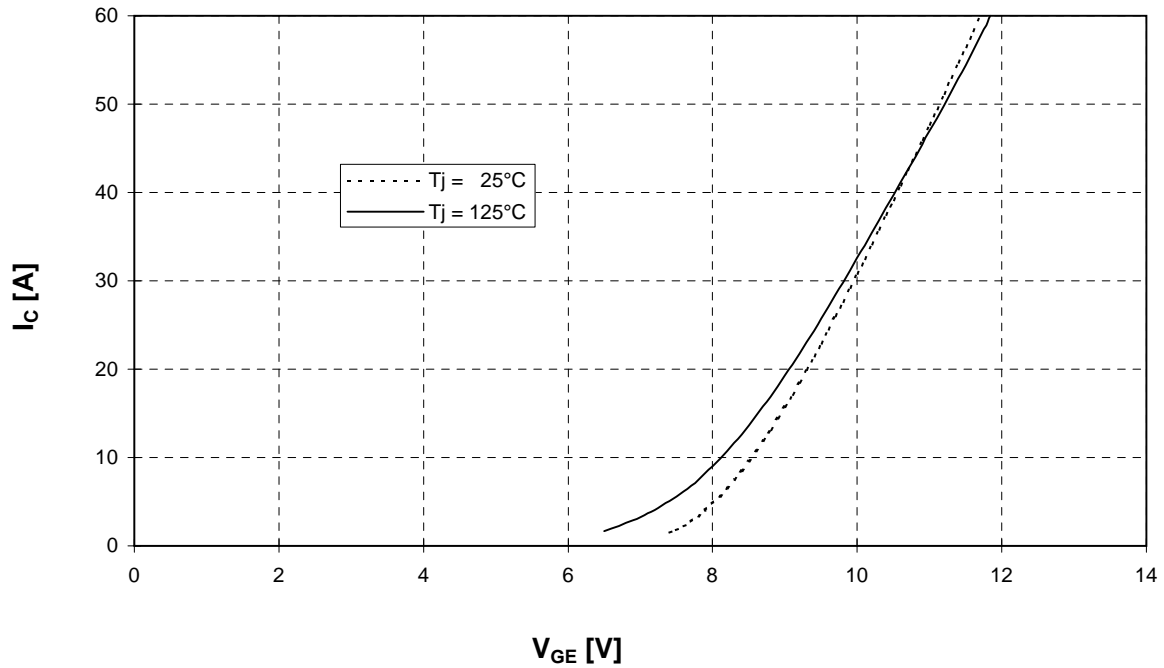


Übertragungscharakteristik Wechselr. (typisch)

Transfer characteristic Inverter (typical)

$i_c = f(V_{GE})$

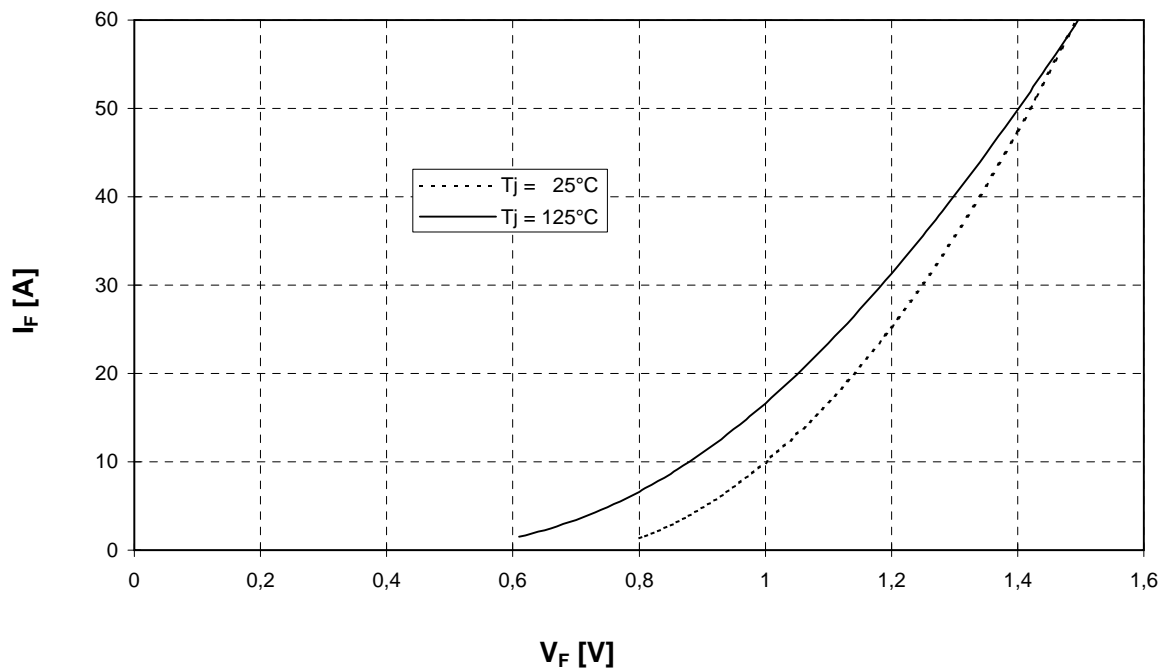
$V_{CE} = 20\text{ V}$

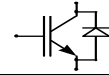


Durchlaßkennlinie der Freilaufdiode Wechselr. (typisch)

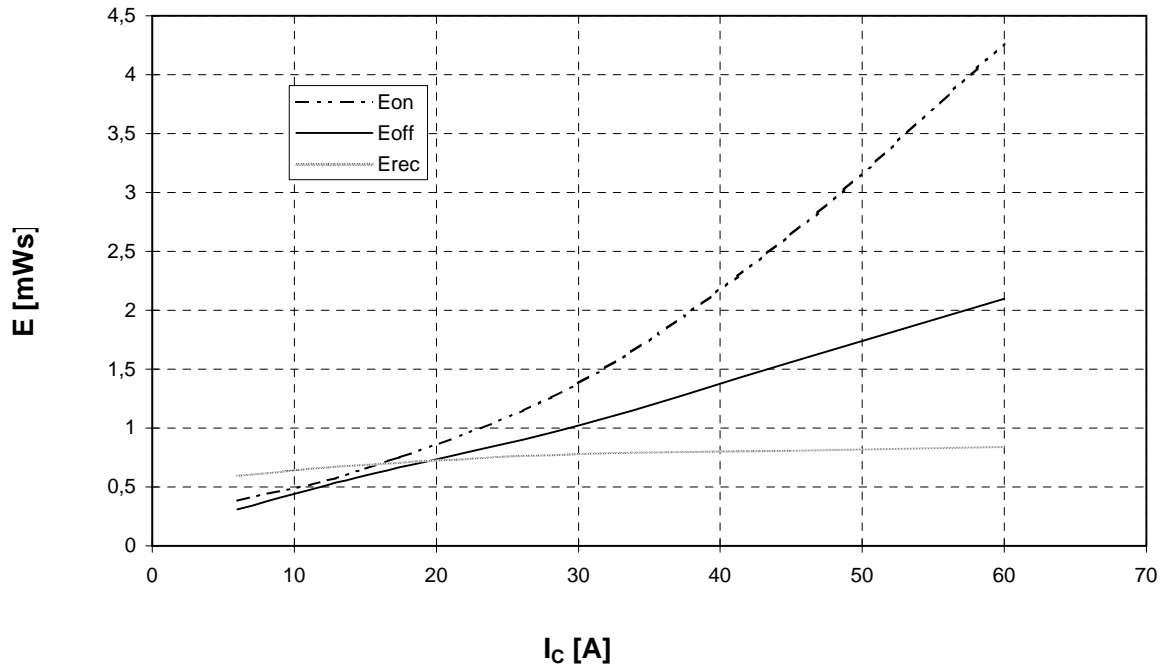
Forward characteristic of FWD Inverter (typical)

$i_F = f(V_F)$

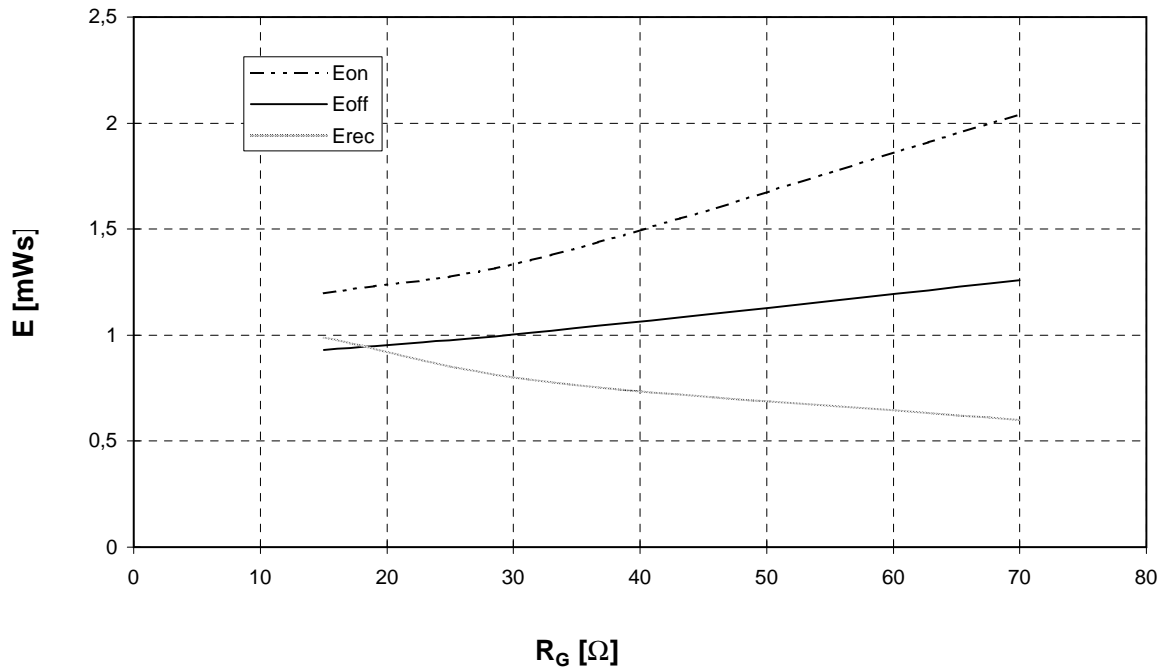


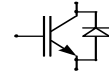


Schaltverluste Wechselr. (typisch)  $E_{on} = f(I_C), E_{off} = f(I_C), E_{rec} = f(I_C)$   $V_{CC} = 300\text{ V}$   
 Switching losses Inverter (typical)  $T_j = 125^\circ\text{C}, V_{GE} = \pm 15\text{ V}, R_{Gon} = R_{Goff} = 33\text{ Ohm}$



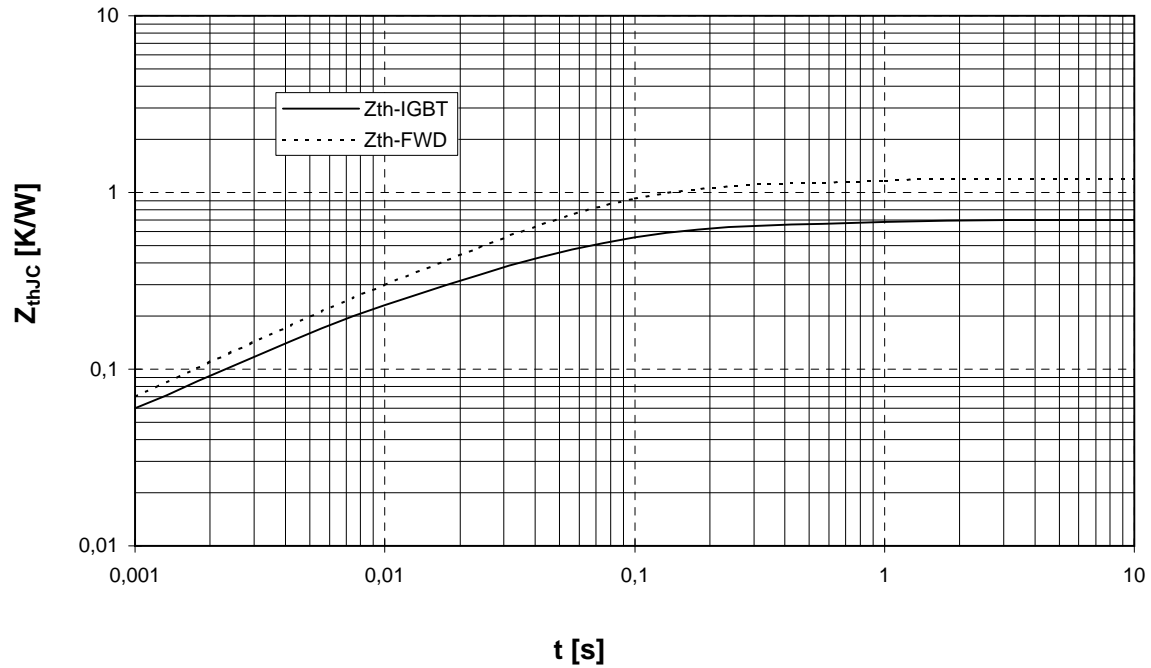
Schaltverluste Wechselr. (typisch)  $E_{on} = f(R_G), E_{off} = f(R_G), E_{rec} = f(R_G)$   
 Switching losses Inverter (typical)  $T_j = 125^\circ\text{C}, V_{GE} = \pm 15\text{ V}, I_C = I_{nenn}, V_{CC} = 300\text{ V}$





Transienter Wärmewiderstand Wechselr.  
Transient thermal impedance Inverter

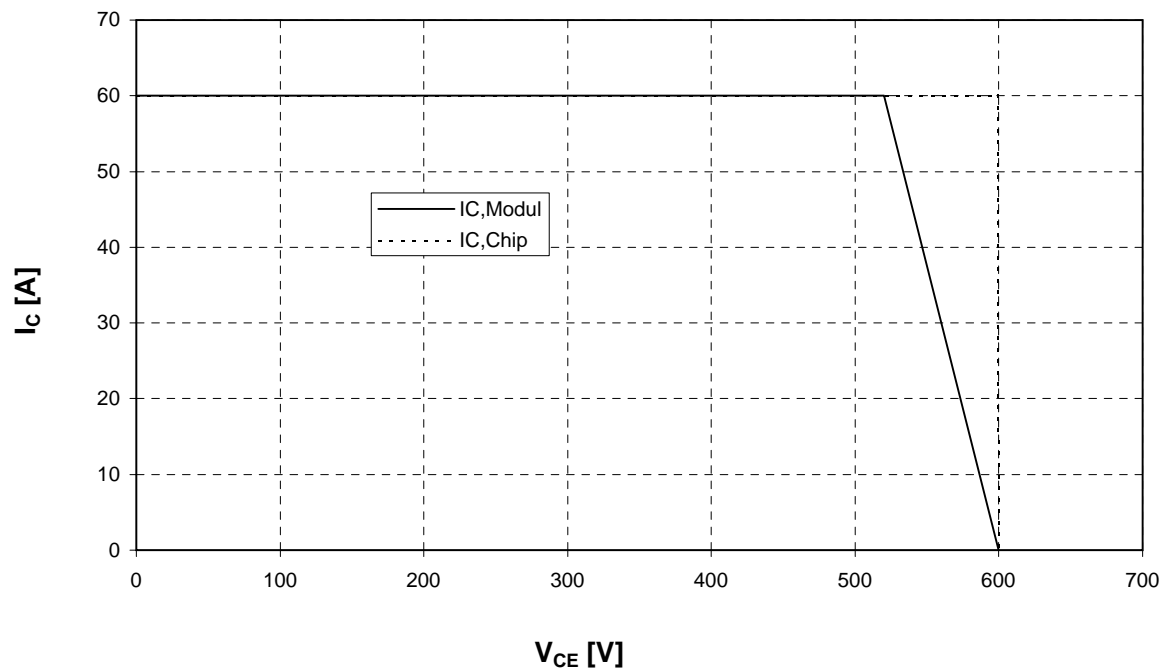
$$Z_{thJC} = f(t)$$



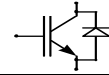
Sicherer Arbeitsbereich Wechselr. (RBSOA)

$$I_c = f(V_{CE})$$

Reverse bias safe operating area Inverter (RBSOA)  $T_{vj} = 125^\circ\text{C}$ ,  $V_{GE} = \pm 15\text{V}$ ,  $R_G = 33\ \Omega$





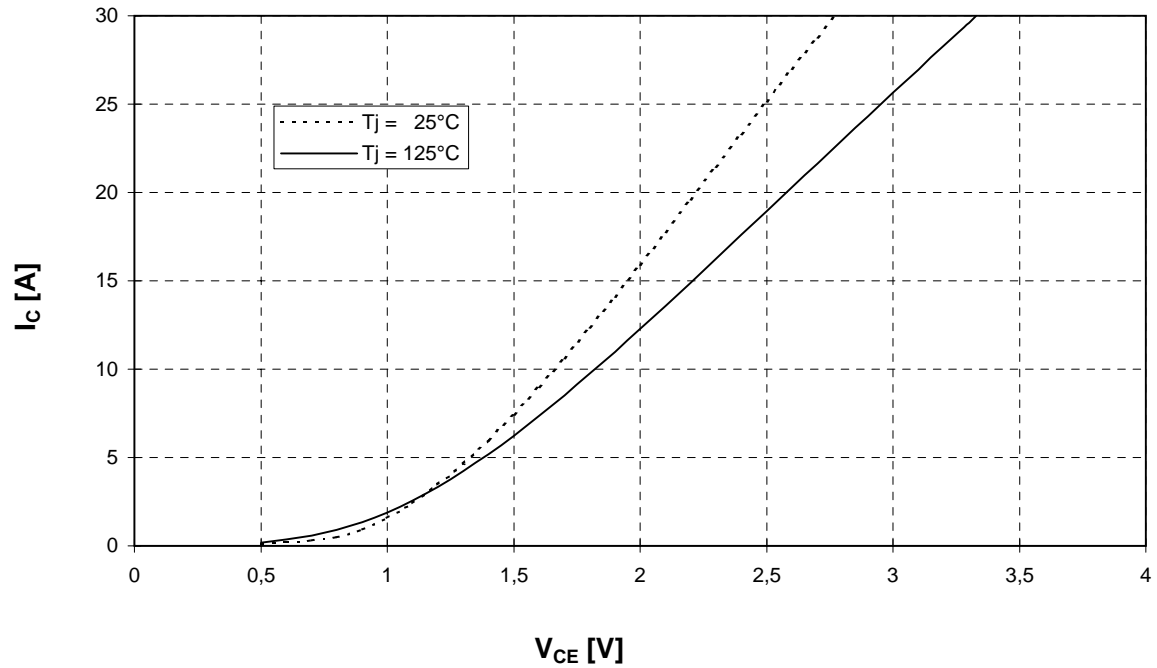


**Ausgangskennlinienfeld Brems-Chopper-IGBT (typisch)**

$d = f(V_{CE})$

**Output characteristic brake-chopper-IGBT (typical)**

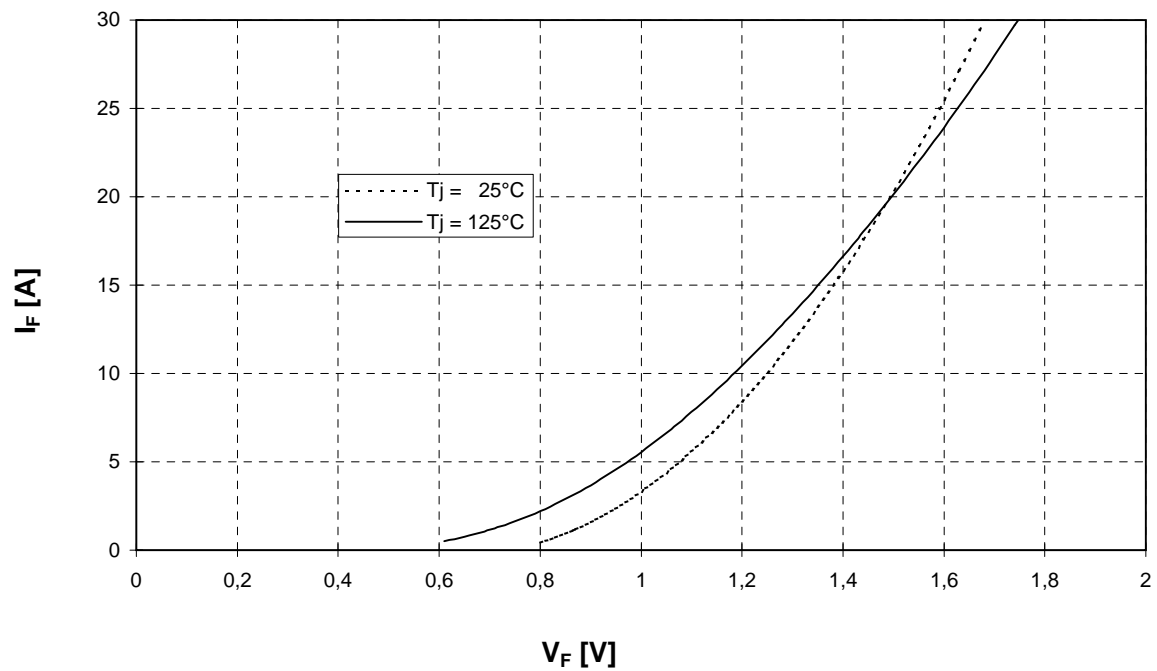
$V_{GE} = 15\text{ V}$

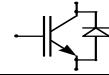


**Durchlaßkennlinie der Brems-Chopper-Diode (typisch)**

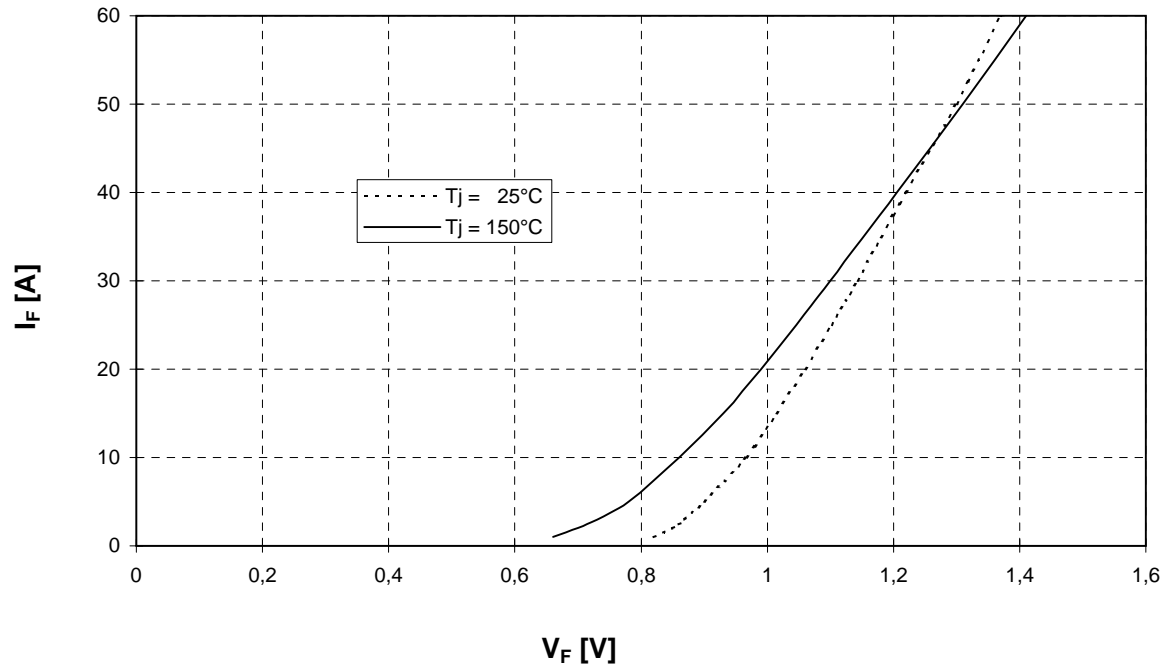
$i = f(V_F)$

**Forward characteristic of brake-chopper-FWD (typical)**

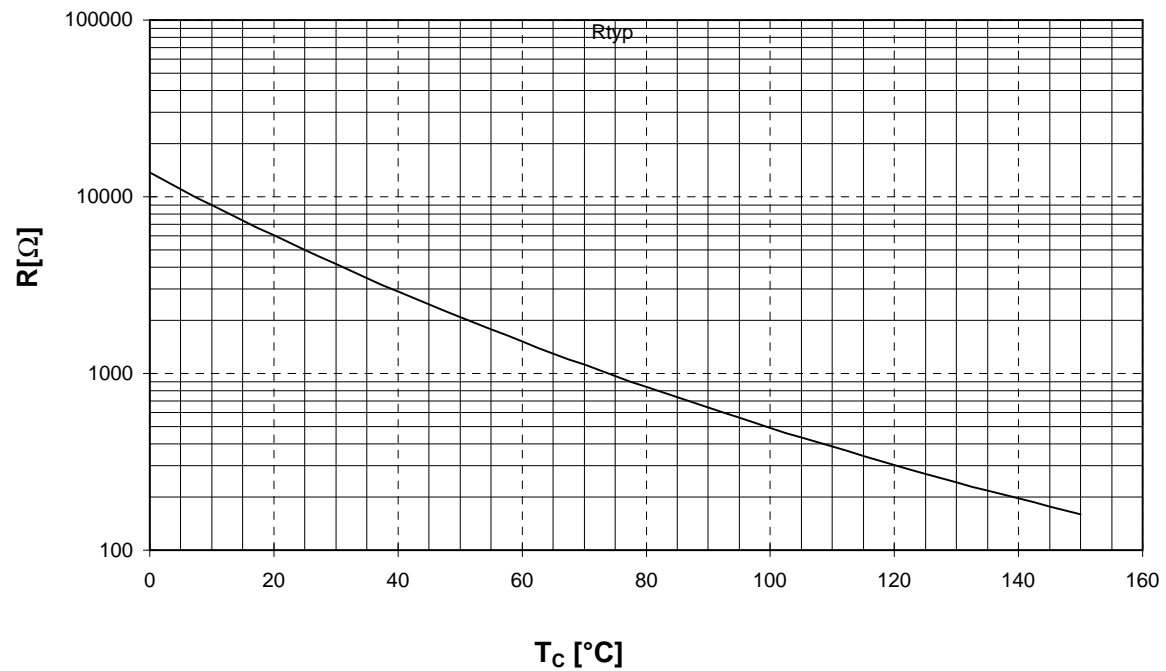


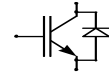


Durchlaßkennlinie der Gleichrichterdiode (typisch)  $\mu = f(V_F)$   
Forward characteristic of Rectifier Diode (typical)

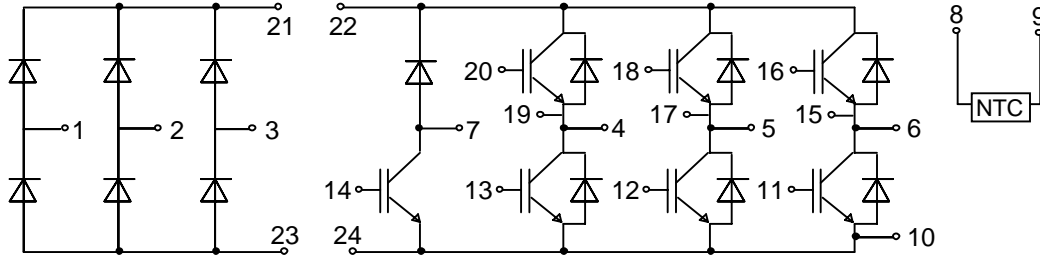


NTC- Temperaturkennlinie (typisch)  $R = f(T)$   
NTC- temperature characteristic (typical)

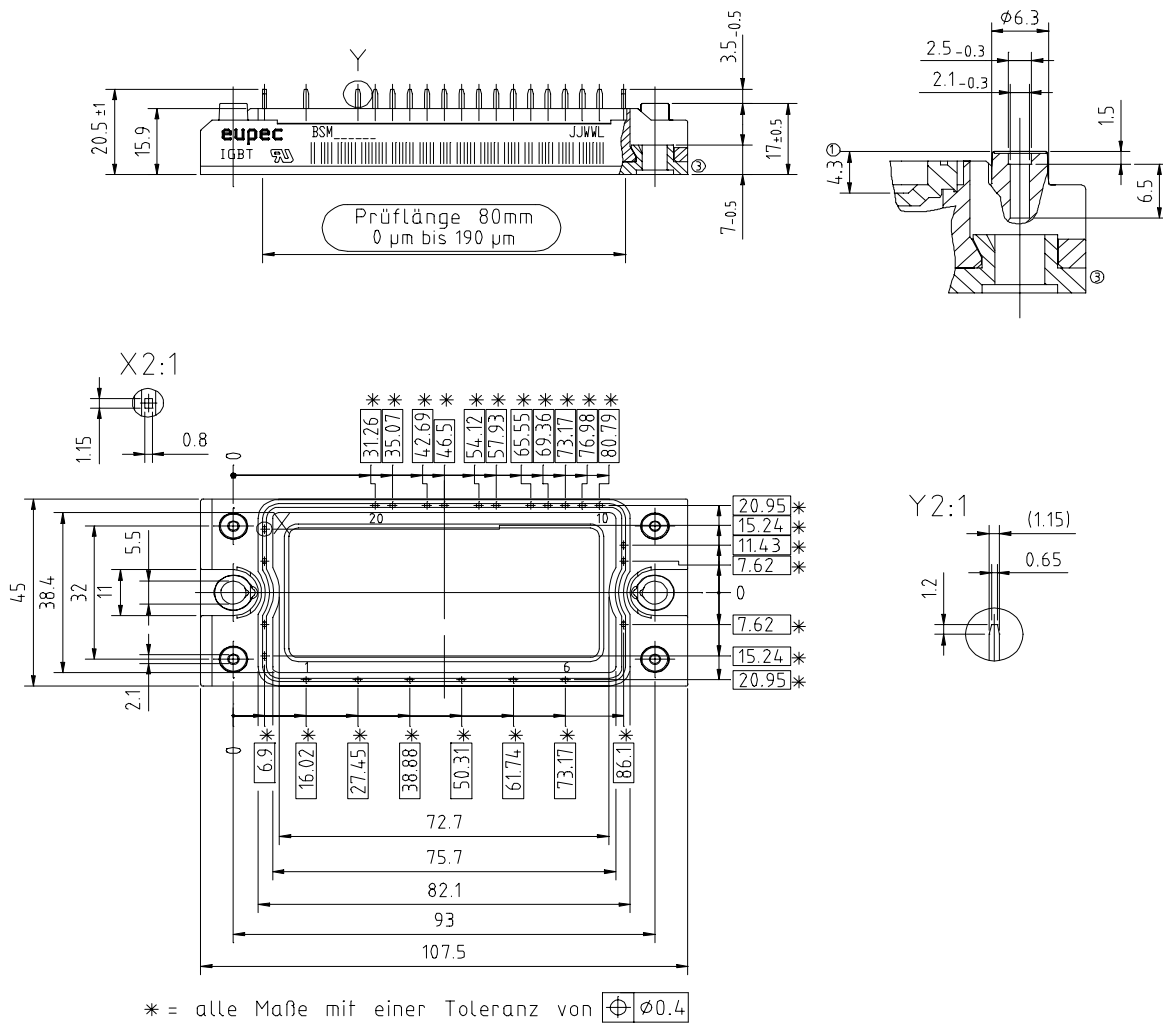




**Schaltplan/ Circuit diagram**



**Gehäuseabmessungen/ Package outlines**



Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.

## **Terms & Conditions of Usage**

### **Attention**

The present product data is exclusively subscribed to technically experienced staff. This Data Sheet is describing the specification of the products for which a warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its specifications. Changes to the Data Sheet are reserved.

You and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application. Should you require product information in excess of the data given in the Data Sheet, please contact your local Sales Office via "[www.eupec.com / sales & contact](http://www.eupec.com / sales & contact)".

### **Warning**

Due to technical requirements the products may contain dangerous substances. For information on the types in question please contact your local Sales Office via "[www.eupec.com / sales & contact](http://www.eupec.com / sales & contact)".



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.